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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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RENESAS

RKP201KN

Silicon Epitaxial Trench Pin Diode for Antenna Switching

REJ03G1311-0200 Rev.2.00 Jan 31, 2006

Features

• Adopting the trench structure minimize terminal capacitance. (C = 0.35 pF max)

30-5

- Low forward resistance. (rf = $2.0 \Omega \text{ max}$)
- Low operation current.
- Ultra small leadless Package (0805type; the use of an undersurface electrode structure) for use in compact and products.

Ordering Information

Type No.	Laser Mark	Package Name	Package Code		
RKP201KN	4	MP8	PXSN0002ZA-A		

Pin Arrangement

1 TAT 2	1. Cathode 2. Anode



Absolute Maximum Ratings

 $(Ta = 25^{\circ}C)$

Item	Symbol	Value	Unit
Reverse voltage	V _R	30	V
Forward current	l _F	100	mA
Power dissipation	Pd	100	mW
Junction temperature	Tj	125	°C
Storage temperature	Tstg	–55 to +125	۵°

Electrical Characteristics

 $(Ta = 25^{\circ}C)$

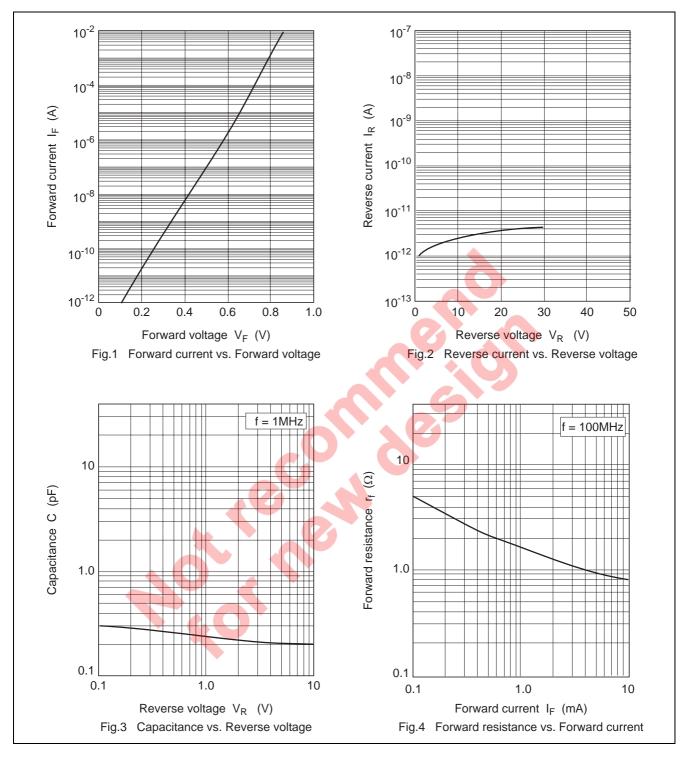
Item	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse current	I _R	—	—	100	nA 🗸	$V_R = 30 V$
Forward voltage	V _F	—	—	0.9	V	$I_F = 2 \text{ mA}$
Capacitance	С	—	_	0.35	pF	V _R = 1 V, f = 1 MHz
Forward resistance	r _f	—	_	2.0	Ω	J _F = 2 mA, f = 100 MHz
ESD-Capability *1	—	100	—	—	V	$C = 200 \text{ pF}, R = 0 \Omega$, Both forward
						and reverse direction 1 pulse.

Notes: 1. Failure criterion ; $I_R > 100 \text{ nA}$ at V_R = 30 V

2. Please do not use the soldering iron due to avoid high stress to the MP8 package.



Main Characteristics



Package Dimensions

MP8 PXSM002ZAA MP8V 0.0023g Under development	MP8			Previous Code	MASS[Typ.]	_			
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